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MOSFET – Power, Single, N-Channel, SO-8FL

30 V, 1.7 mΩ, 136 A

NTMFS4C022N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Parameter		Symbol	Value	Unit		
Drain-to-Source Voltage			V _{DSS}	30	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain Current $R_{\theta JC}$ (Notes 1, 3)	Steady	$T_{\rm C} = 25^{\circ}{\rm C}$	۱ _D	136	A	
Power Dissipation $R_{\theta JC}$ (Notes 1, 3)	State	$T_C = 25^{\circ}C$	P _D	64	W	
Continuous Drain Current $R_{\theta JA}$ (Notes 1, 2, 3)	Steady State	Boux (Notes 1, 2, 3)		Ι _D	30	A
Power Dissipation $R_{\theta JA}$ (Notes 1, 2, 3)		$T_A = 25^{\circ}C$	P _D	3.1	W	
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	–55 to 150	°C		
Source Current (Body Diode)		IS	53	А		
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 11 A)		E _{AS}	549	mJ		
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		ΤL	260	°C		

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

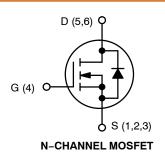
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State (Note 2)	$R_{\theta JC}$	1.95	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	40	

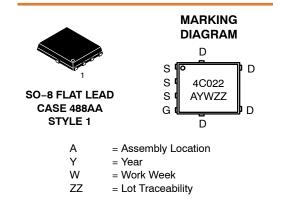
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
30 V	1.7 mΩ @ 10 V	100 4
30 V	2.6 mΩ @ 4.5 V	136 A





ORDERING INFORMATION

Device	Package	Shipping [†]		
NTMFS4C022NT1G	SO-8FL (Pb-Free)	1500 / Tape & Reel		
NTMFS4C022NT3G	SO-8FL (Pb-Free)	5000 / Tape & Reel		

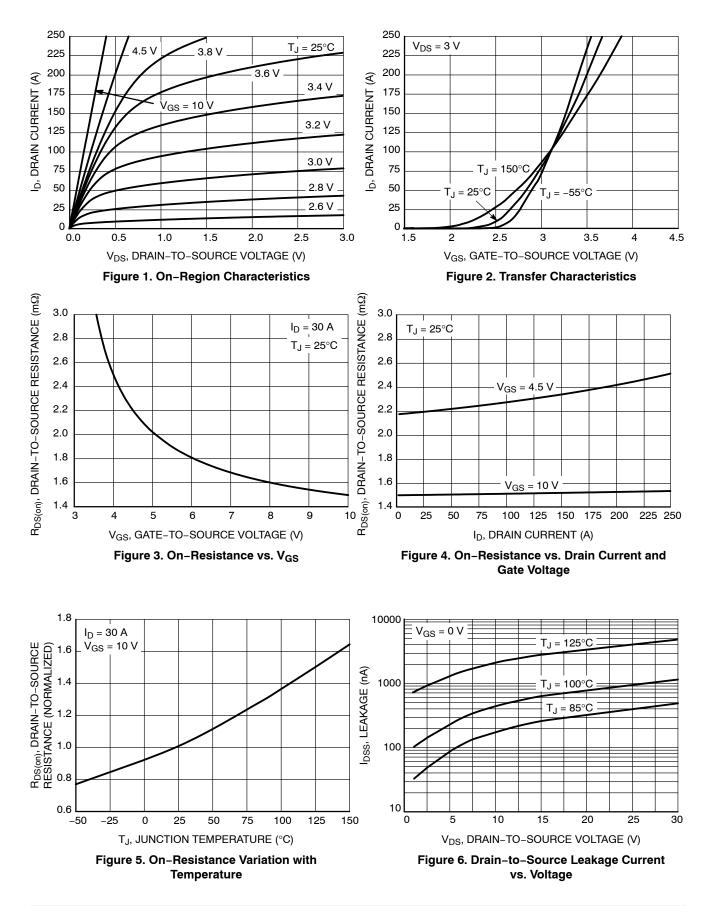
+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

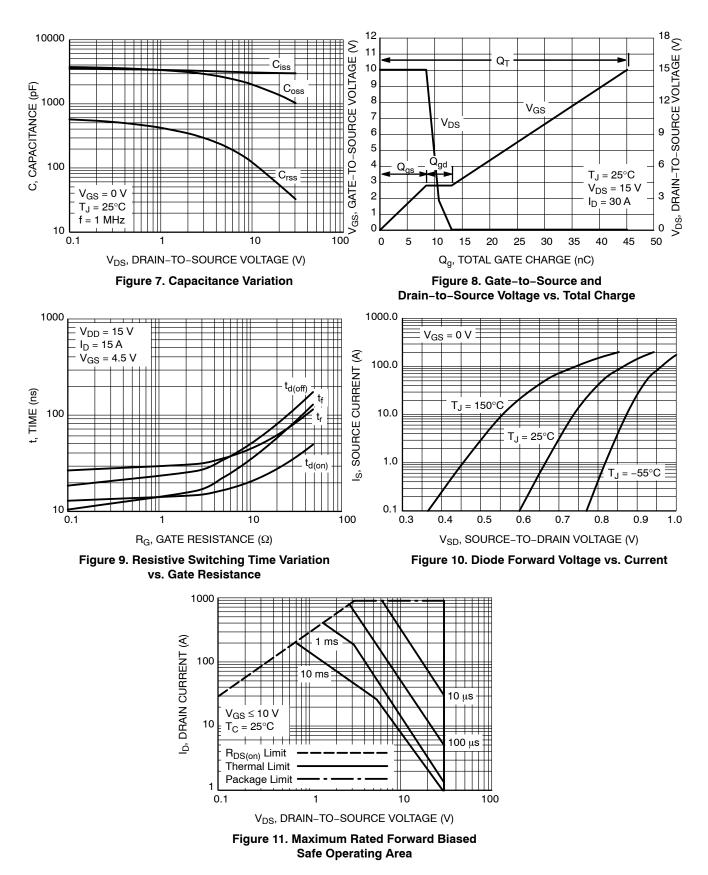
Parameter	Symbol	Test Cond	dition	Min	Тур	Max	Unit
OFF CHARACTERISTICS							
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I _D	= 250 μA	30			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				18.2		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V, V _{DS} = 24 V	T _J = 25 °C			1	μΑ
			T _J = 125°C			10	
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_{D}$	e = 250 μA	1.3		2.2	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} /T _J				4.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A		1.4	1.7	mΩ
		V _{GS} = 4.5 V	I _D = 30 A		2.0	2.6	
Forward Transconductance	9 _{FS}	V _{DS} = 3 V, I _E	₀ = 30 A		136		S
Gate Resistance	R _G	T _A = 25 °C			1.0		Ω
CHARGES AND CAPACITANCES							
Input Capacitance	C _{ISS}				3071		1
Output Capacitance	C _{OSS}	V_{GS} = 0 V, f = 1 MHz, V_{DS} = 15 V			1673		pF
Reverse Transfer Capacitance	C _{RSS}				67		
Total Gate Charge	Q _{G(TOT)}				20.8		1
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 4.5 V, V _{DS} = 15 V; I _D = 30 A			4.9		nC
Gate-to-Source Charge	Q _{GS}				8.5		
Gate-to-Drain Charge	Q _{GD}				4.7		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 15 V, I _D = 30 A			45.2		nC
SWITCHING CHARACTERISTICS (Note 5)							
Turn–On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 15 V, I_{D} = 15 A, R_{G} = 3.0 Ω			14		- ns
Rise Time	t _r				32		
Turn-Off Delay Time	t _{d(OFF)}				27		
Fall Time	t _f				17		
DRAIN-SOURCE DIODE CHARACTERISTIC	S						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.75	1.1	
		$I_{\rm S} = 10 {\rm A}$	T _J = 125°C		0.6		V
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dI _S /dt = 100 A/µs, I _S = 30 A			47		ns
Charge Time	t _a				23		
Discharge Time	t _b				24		
Reverse Recovery Charge	Q _{RR}				39		nC

performance may not be indicated by the Electrical Characteristics if operated under different conditions.
Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

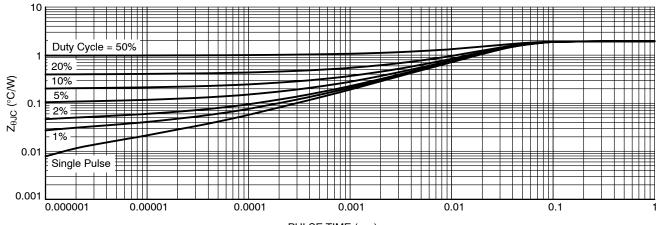
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

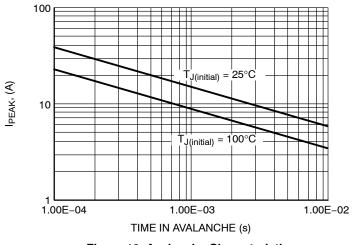


TYPICAL CHARACTERISTICS



PULSE TIME (sec)







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